

General Description

The MAX811xEUS+T is low-power microprocessor (μP) supervisory circuits used to monitor power sup-plies in μP and digital systems.

They provide excellent circuit reliability and low cost by eliminating external components and adjustments when used with 5V-powered or 3V-powered circuits.

The MAX811xEUS+T also provide a debounced manual reset input. The only difference between the two devices is that the MAX811xEUS+T has an active-low RESET output (which is guaranteed to be in the correct state for VCC down to 1V). Reset thresholds are available for operation with a variety of supply voltages.

Features

- Precision Monitoring of 3V, 3.3V, and 5V
 Power-Supply Voltages
- 140ms Min Power-On Reset Pulse Width
- Guaranteed Over Temperature
- Guaranteed RESET Valid to VCC = 1V
- SOT-143 package

Selection Table

Part No	Detectable	Package
	Voltage	. donago
MAX811LEUS+T	4.63V	
MAX811MEUS+T	4.38V	SOT-143
MAX811TEUS+T	3.08V	(SOT-143-4)
MAX811SEUS+T	2.93V	
MAX811REUS+T	2.63V	

Pin Assignment



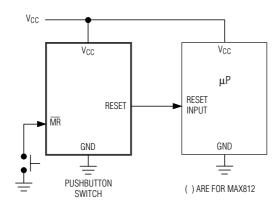
SOT-143(SOT-143-4)

PIN NO	PIN NAME	FUNCTION
1	GND	Ground
2	RESET	Active-Low Reset Output
3	MR	Manual Reset Input
4	VCC	Supply Voltage

Applications

- Computers
- Controllers
- Intelligent Instruments
- Portable/Battery-Powered Equipment

Application Circuits



Absolute Maximum Ratings

Input Voltage0.	3V to 6.0V	Storage Temperature40°C	to 125℃
Operating Temperature40	0°C to 85°C		

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

Thermal Information

Symbol	Parameter	Max.	Unit
θ ЈА	Thermal Resistance (Junction to Ambient) (Assume no ambient airflow, no heat sink)	260	°C/W
P _D	Power Dissipation	0.32	W

Note: P_D is measured at Ta= $25\,^{\circ}\!\mathrm{C}$

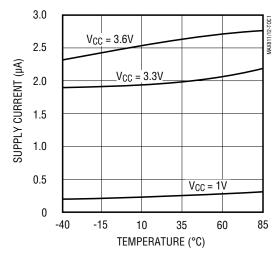


Electrical Characteristics

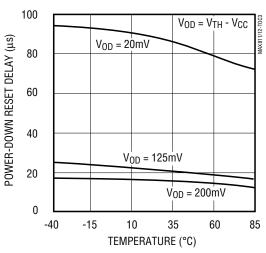
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Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit	
Vcc	Input Voltage (Vcc) Range	TA=25°C	1.2		5.5	٧	
Iss	Supply Current	MAX811L/M:VCC < 5.5V MAX811R/S/T:VCC < 3.6V		6 2.7	15 10	μА	
	Reset	MAX811L:TA=25℃	4.54	4.63	4.72		
		MAX811MTA=25℃	4.30	4.38	4.46		
V_{DET}	Threshold	MAX811T:TA=25℃	3.03	3.08	3.14	V	
	Tillesiloid	MAX811S:TA=25℃	2.88	2.93	2.98		
		MAX811R:TA=25℃	2.58	2.63	2.68		
	Reset Threshold Stability			30		Ppm/ ℃	
	V _{CC} to Reset Delay	VOD=125mV,MAX811L/M: VOD=125mV,MAX811R/S/T:		40 20		us	
t _{RP}	Reset Threshold Tempco	VCC=VTH(MAX)	140		560	ms	
t _{MR}	MR Minimum Pulse Width Tempco		10			us	
	MR Glitch Immunity			100		ns	
t _{MD}	MR to Reset Propagation Delay			0.5		us	
V_{IH}		VCC > VTH(MAX),MAX811L/M	2.3				
VIL	MR Input	` '			8.0	V	
VH	Threshold	VCC > VTH(MAX),MAX811R/S/T	0.7xVCC			V	
VIL		V 0 0 7 V 111 (W) 0 V (), W) 0 V 0 1 11 V 0 / 1			0.25xVCC		
t _{MD}	MR Pull-Up Resistance		10	20	30	kΩ	
V _{OL}	RESET Output Voltage Low	MAX811L/M:VCC=VTH min,ISINK=1.2mA MAX811R/S/T:VCC=VTH min,ISINK=3.2mA ISINK=50uA,VCC > 1.0V			0.4 0.3	V	
Vон	RESET Output Voltage High	MAX811L/M only,ISOURCE=150uA MAX811R/S/T only,ISOURCE=150uA VCC > VTH(MAX)	0.8 VCC VCC-1.5			V	



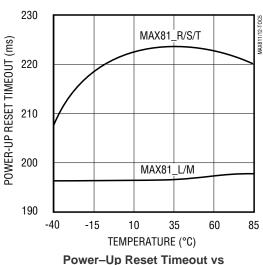
Typical Characteristics



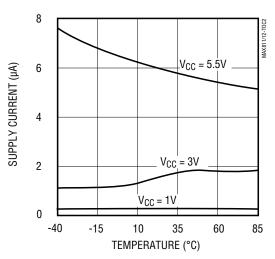
Supply Current vs Temperature (No Load, MAX811R/S/T)



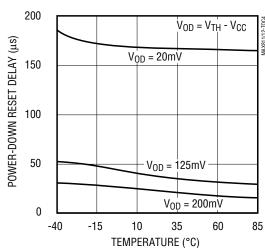
Power–Down Reset Delay vs Temperature and (MAX811R/S/T)



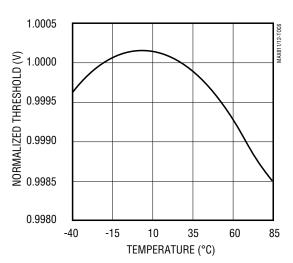
Power–Up Reset Timeout vs
Temperature



Supply Current vs Temperature (No Load, MAX811L/M/)



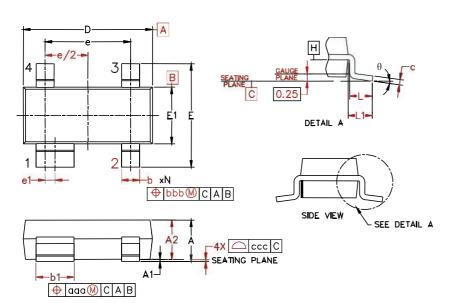
Power-Down Reset Delay vs Temperature and (MAX811L/M)



Normalized Reset Threshold vs Temperature



SOT-143(SOT-143-4) Package Outline Dimensions



0	Inches			Millimeters		
Symbol	Min.	Nom.	Max.	Min.	Nom.	Max.
Α	0.031	1	0.048	0.80	1	1.22
A 1	0.000	ı	0.008	0.013	1	0.15
A2	0.020	0.035	0.042	0.75	0.90	1.07
b	0.011	-	0.020	0.30	-	0.51
b1	0.029	1	0.037	0.76	1	0.94
С	0.003	1	0.008	0.08	1	0.20
D	0.110	0.114	0.120	2.80	2.90	3.04
E	0.082	0.093	0.104	2.10	2.37	2.64
E1	0.047	0.051	0.055	1.20	1.30	1.40
е		0.075		1.92 BSC		
e1		0.008 0.20 BSC			С	
L	0.015	0.020	0.024	0.40 0.50 0.		0.60
L1	(0.021)				(0.54)	
N	4 4					
θ	0°	-	8°	0°	-	8°
aaa		0.006		0.15		
bbb		0.008		0.20		
ссс		0.004		0.10		



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